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STW48N60M2-4



N-channel 600 V, 0.06 Ω typ., 42 A MDmesh™ M2 Power MOSFET in a TO247-4 package

Datasheet - production data

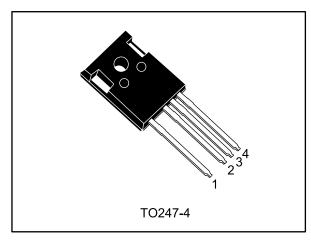
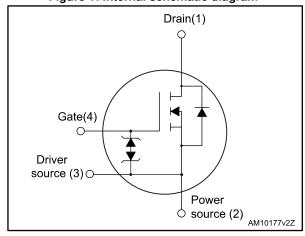


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax.}	R _{DS(on)} max.	I _D
STW48N60M2-4	650 V	0.07 Ω	42 A

- Excellent switching performance thanks to the extra driving source pin
- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

Applications

- High efficiency switching applications:
 - Servers
 - PV inverters
 - Telecom infrastructure
 - Multi kW battery chargers

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW48N60M2-4	48N60M2	TO247-4	Tube

Contents STW48N60M2-4

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STW48N60M2-4 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate- source voltage	±25	V
I_D	Drain current (continuous) at T _C = 25 °C	42	Α
ID	Drain current (continuous) at T _C = 100 °C	26	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	168	Α
P _{TOT}	Total dissipation at T _C = 25 °C	300	W
I _{AR}	Max. current during repetitive or single pulse avalanche (pulse width limited by T _{jmax.})	7	Α
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	1	J
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	FF to 1F0	°C
T _j	Operating junction temperature range	- 55 to 150	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max.	0.42	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max.	50	°C/W

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 42$ A, di/dt = 400 A/ μ s, $V_{DS(peak)} < V_{(BR)DSS}, V_{DD} = 400$ V

 $^{^{(3)}}V_{DS} \le 480 \text{ V}$

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On /off-states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			V
1	Zero-gate voltage	V _{DS} = 600 V			1	μΑ
IDSS	drain current ($V_{GS} = 0$)	$V_{DS} = 600 \text{ V}, T_{C} = 125 {}^{\circ}\text{C}^{(1)}$			100	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			±10	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 21 A		0.06	0.07	Ω

Notes:

Table 5: Dynamic

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	3060	1	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	-	143	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0	-	4.3	1	pF
Coss eq. (1)	Equivalent Output Capacitance	$V_{GS} = 0$, $V_{DS} = 0$ to 480 V	1	630	ı	pF
Rg	Intrinsic gate resistance	f = 1 MHz open drain	-	4.6	1	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 42 \text{ A},$	-	70	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	10.5	1	nC
Q_{gd}	Gate-drain charge	See Figure 15: "Gate charge test circuit"	-	31	-	nC

Notes:

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 21 \text{ A},$	-	18.5	-	ns
tr	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	17	-	ns
t _{d(off)}	Turn-off-delay time	See Figure 14: "Switching times test circuit for resistive load" and	-	13	-	ns
tr	Fall time	Figure 19: "Switching time waveform"	-	119	-	ns

 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

 $^{^{(1)}}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDss.

Table 7: Source-drain diode

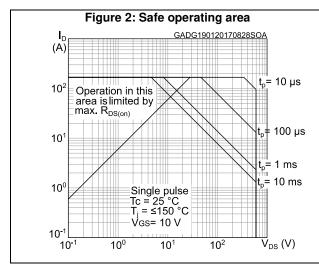
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		42	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		168	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 21 A, V _{GS} = 0	-		1.6	V
trr	Reverse recovery time	I _{SD} = 42 A, di/dt = 100 A/μs V _{DD} = 60 V See Figure 16: " Test circuit for inductive load switching and diode recovery times"	-	487		ns
Qrr	Reverse recovery charge		-	9.1		μC
I _{RRM}	Reverse recovery current		-	37.5		Α
t _{rr}	Reverse recovery time	$I_{SD} = 42 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ See Figure 16: " Test circuit for	-	605		ns
Q _{rr}	Reverse recovery charge		-	12.5		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times"	-	41.5		Α

Notes:

 $^{^{(1)}}$ Pulse width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%.

2.2 Electrical characteristics (curves)



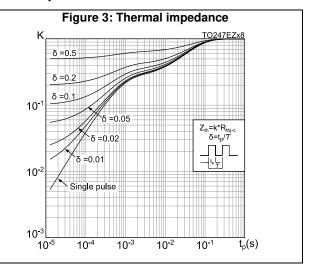
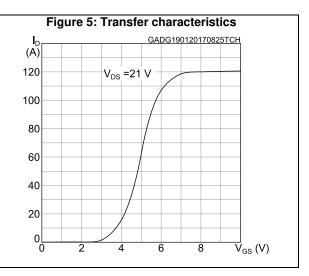
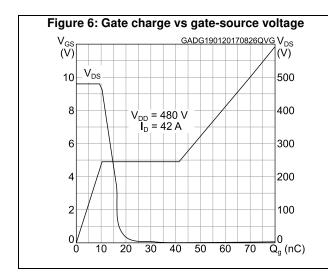
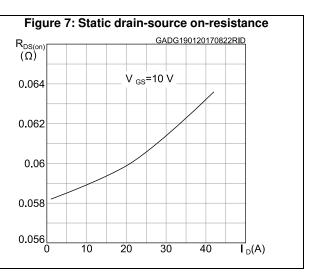
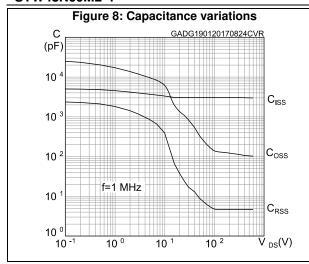


Figure 4: Output characteristics GADG190120170825OCH **I**_D (Α) $V_{GS} = 8, 9, 10 V$ 120 7 V 100 6 V 80 60 5 V 40 20 4 V 20 12 16 $\overline{V}_{DS}(V)$



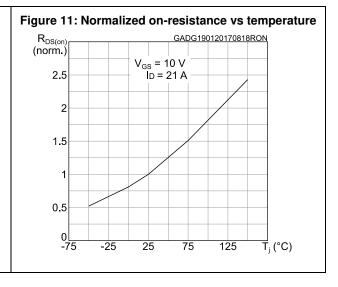


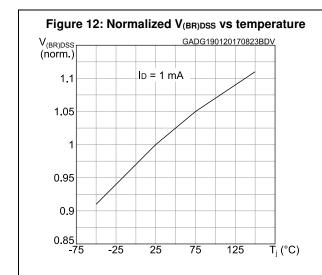


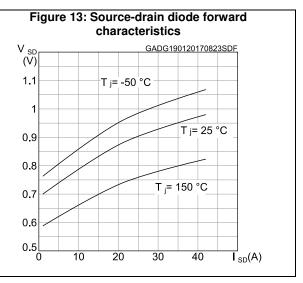


E_{OSS} GADG190120170827EOS (µJ) 20 16 12 8 4 4 0 0 100 200 300 400 500 600 V_{DS} (V)

Figure 10: Normalized gate threshold voltage vs temperature $V_{GS(th)}$ (norm.) 1.1 $ID = 250 \ \mu A$ 0.9 0.8 0.7 0.6 -75 -25 25 75 125 T_{j} (°C)

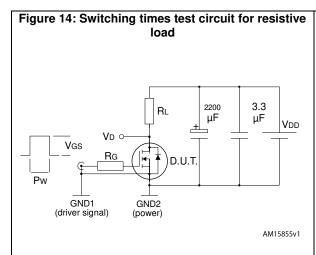






Test circuits STW48N60M2-4

3 Test circuits



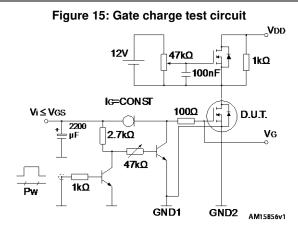
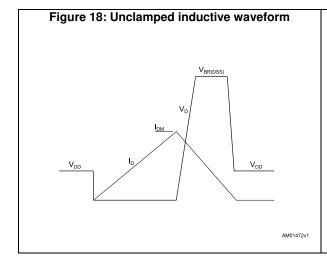
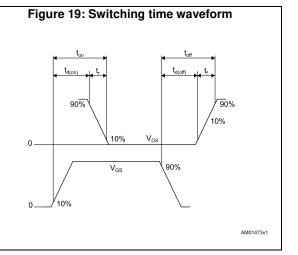


Figure 17: Unclamped inductive load test circuit





4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO247-4 package information

øP1 Α2 \Box D3 øP2 Α1 b2 b (x4) e (x2) SECTION A-A BASE METAL WITH PLATING b1 8405626_A

Figure 20: TO247-4 package outline

Table 8: TO247-4 mechanical data

Table 8: 10247-4 mechanical data				
Dim.		mm		
Dilli.	Min.	Тур.	Max.	
А	4.90	5.00	5.10	
A1	2.31	2.41	2.51	
A2	1.90	2.00	2.10	
b	1.16		1.29	
b1	1.15	1.20	1.25	
b2	0		0.20	
С	0.59		0.66	
c1	0.58	0.60	0.62	
D	20.90	21.00	21.10	
D1	16.25	16.55	16.85	
D2	1.05	1.20	1.35	
D3	24.97	25.12	25.27	
E	15.70	15.80	15.90	
E1	13.10	13.30	13.50	
E2	4.90	5.00	5.10	
E3	2.40	2.50	2.60	
е	2.44	2.54	2.64	
e1	4.98	5.08	5.18	
L	19.80	19.92	20.10	
Р	3.50	3.60	3.70	
P1			7.40	
P2	2.40	2.50	2.60	
Q	5.60		6.00	
S		6.15		
Т	9.80		10.20	
U	6.00		6.40	

STW48N60M2-4 Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
25-Jul-2014	1	Initial release.
30-Jan-2015	2	Added section Electrical characteristics (curves).
20-Jan-2017	3	Updated Table 2: "Absolute maximum ratings", Table 4: "On /off-states", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Updated Section 2.2: "Electrical characteristics (curves)".

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